

74F539

Dual 1-of-4 Decoder with 3-STATE Outputs

General Description

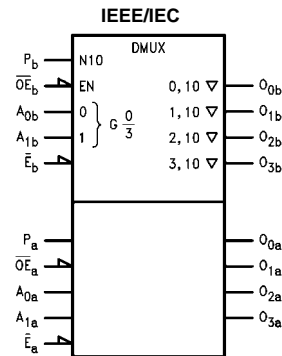
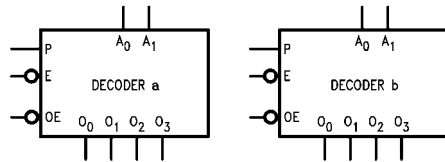
The 74F539 contains two independent decoders. Each accepts two Address (A_0, A_1) input signals and decodes them to select one of four mutually exclusive outputs. A polarity control input (P) determines whether the outputs are active HIGH ($P = L$) or active LOW ($P = H$). An active LOW input Enable (E) is available for data demultiplexing; data is routed to the selected output in non-inverted form in the active LOW mode or in inverted form in the active HIGH mode. A HIGH signal on the active LOW Output Enable (\overline{OE}) input forces the 3-STATE outputs to the high impedance state.

Ordering Code:

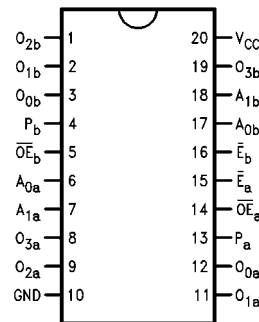
Order Number	Package Number	Package Description
74F539SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F539PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



74F539 Dual 1-of-4 Decoder with 3-STATE Outputs

Unit Loading/Fan Out

Pin Names	Description	U.L.		Input I_{IH}/I_{IL}
		HIGH	LOW	Output I_{OH}/I_{OL}
$A_{0a}-A_{1a}$	Side A Address Inputs	1.0	1.0	$20 \mu\text{A}/-0.6 \text{ mA}$
$A_{0b}-A_{1b}$	Side B Address Inputs	1.0	1.0	$20 \mu\text{A}/-0.6 \text{ mA}$
\bar{E}_a, \bar{E}_b	Enable Inputs (Active LOW)	1.0	1.0	$20 \mu\text{A}/-0.6 \text{ mA}$
\bar{OE}_a, \bar{OE}_b	Output Enable Inputs (Active LOW)	1.0	1.0	$20 \mu\text{A}/-0.6 \text{ mA}$
P_a, P_b	Polarity Control Inputs	1.0	1.0	$20 \mu\text{A}/-0.6 \text{ mA}$
$O_{0a}-O_{3a}$	Side A 3-STATE Outputs	150/40	(33.3)	$-3 \text{ mA}/24 \text{ mA}$ (20 mA)
$O_{0b}-O_{3b}$	Side B 3-STATE Outputs	150/40	(33.3)	$-3 \text{ mA}/24 \text{ mA}$ (20 mA)

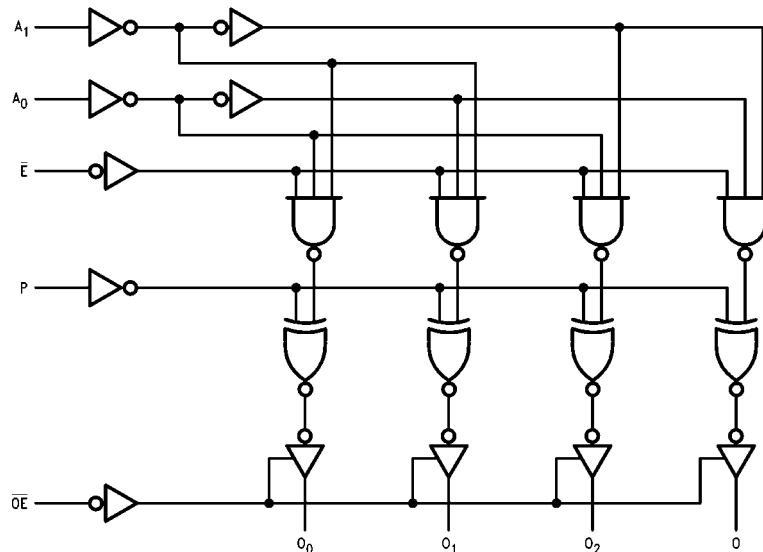
Truth Table

(each half)

Function	Inputs				Outputs			
	\bar{OE}	\bar{E}	A_1	A_0	O_0	O_1	O_2	O_3
High Impedance	H	X	X	X	Z	Z	Z	Z
Disable	L	H	X	X	$O_n = P$			
Active HIGH	L	L	L	L	H	L	L	L
Output	L	L	L	H	L	H	L	L
(P = L)	L	L	H	L	L	L	H	L
	L	L	H	H	L	L	L	H
Active LOW	L	L	L	L	L	H	H	H
Output	L	L	L	H	H	L	H	H
(P = H)	L	L	H	L	H	H	L	H
	L	L	H	H	H	H	H	L

H = HIGH Voltage Level
L = LOW Voltage LevelX = Immaterial
Z = High Impedance

Logic Diagram (one half shown)



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V _{CC} = 0V)	
Standard Output	-0.5V to V _{CC}
3-STATE Output	-0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I _{OL} (mA)

Recommended Operating Conditions

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

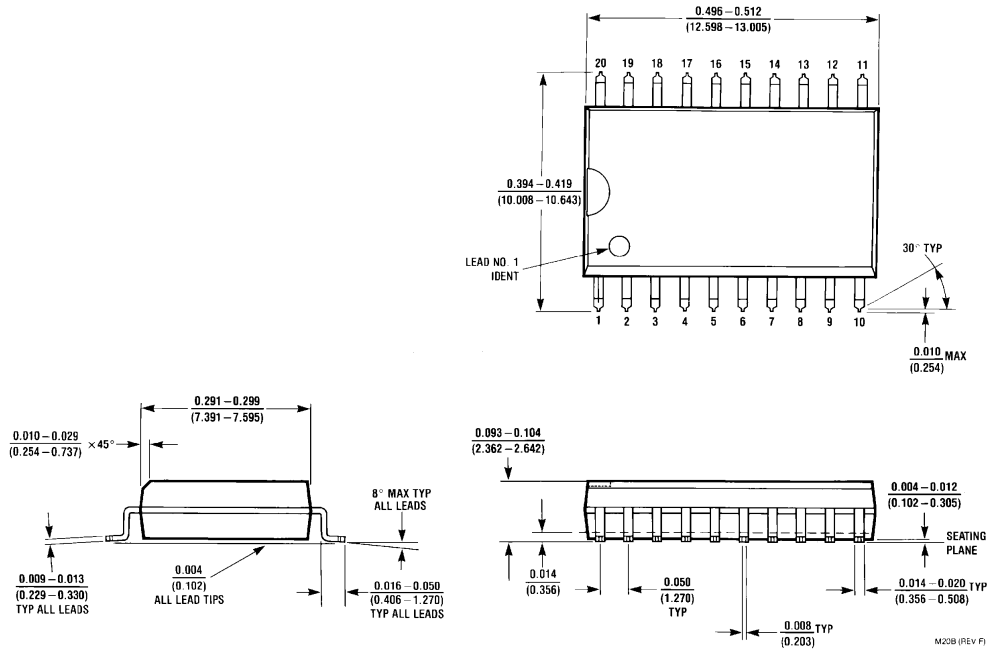
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	10% V _{CC} 10% V _{CC} 5% V _{CC} 5% V _{CC}	2.5 2.4 2.7 2.7		V	Min	I _{OH} = -1 mA I _{OH} = -3 mA I _{OH} = -1 mA I _{OH} = -3 mA
V _{OL}	Output LOW Voltage	10% V _{CC}		0.5	V	Min	I _{OL} = 24 mA
I _{IH}	Input HIGH Current			5.0	μA	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test			7.0	μA	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current			50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current			3.75	μA	0.0	V _{IOD} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current			-0.6	mA	Max	V _{IN} = 0.5V
I _{OZH}	Output Leakage Current			50	μA	Max	V _{OUT} = 2.7V
I _{OZL}	Output Leakage Current			-50	μA	Max	V _{OUT} = 0.5V
I _{OS}	Output Short-Circuit Current	-60		-150	mA	Max	V _{OUT} = 0V
I _{ZZ}	Bus Drainage Test			500	μA	0.0V	V _{OUT} = 5.25V
I _{CCH}	Power Supply Current		28	45	mA	Max	V _O = HIGH
I _{CCL}	Power Supply Current		40	60	mA	Max	V _O = LOW
I _{CCZ}	Power Supply Current		40	60	mA	Max	V _O = HIGH Z

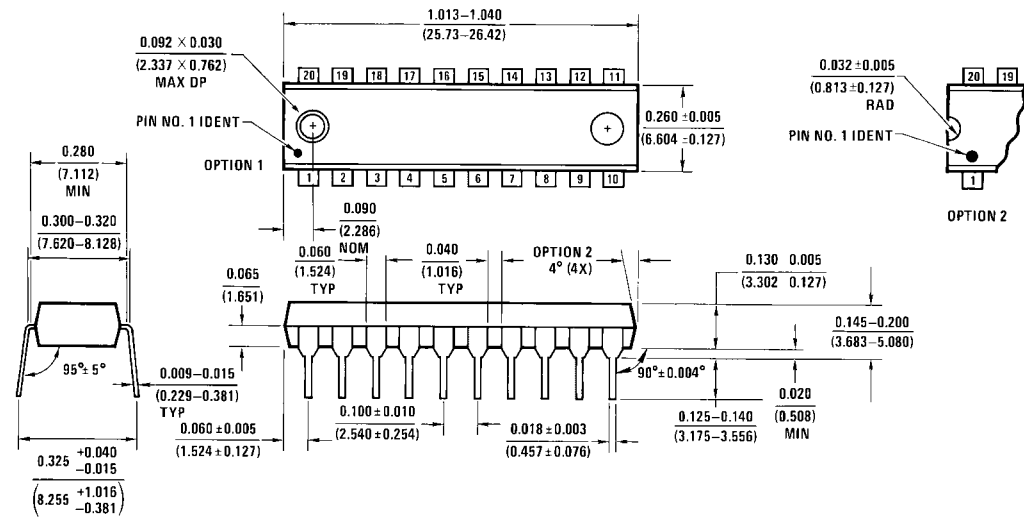
AC Electrical Characteristics							
Symbol	Parameter	T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A = 0°C to +70°C V _{CC} = +5.0V C _L = 50 pF		Units
		Min	Typ	Max	Min	Max	
t _{PLH}	Propagation Delay	4.0	14.5	18.5	3.5	19.5	ns
t _{PHL}	A _n to O _n	4.0	9.5	12.0	4.0	13.0	
t _{PLH}	Propagation Delay	5.0	12.0	16.0	5.5	17.0	ns
t _{PHL}	\bar{E} to O _n	4.0	7.5	9.5	4.0	10.5	
t _{PLH}	Propagation Delay	7.5	14.5	21.5	4.5	22.5	ns
t _{PHL}	P to O _n	5.0	11.0	16.5	4.5	17.5	
t _{PZH}	Output Enable Time	4.5	8.0	10.5	4.0	11.5	ns
t _{PZL}	\bar{OE} to O _n	5.5	10.0	13.0	5.0	14.0	
t _{PHZ}	Output Disable Time	2.0	4.5	6.5	2.0	7.0	
t _{PLZ}	\bar{OE} to O _n	3.0	6.5	8.5	3.0	9.5	

Physical Dimensions inches (millimeters) unless otherwise noted



**20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M20B**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N20A

N20A (REV G)

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